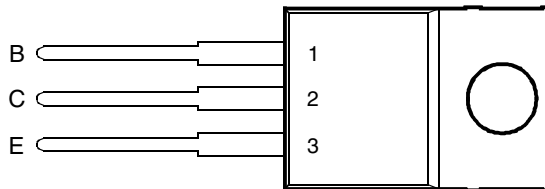




- Designed for Complementary Use with BDX33, BDX33A, BDX33B, BDX33C and BDX33D
- 70 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- Minimum  $h_{FE}$  of 750 at 3V, 3 A

TO-220 PACKAGE  
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

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**absolute maximum ratings at 25°C case temperature (unless otherwise noted)**

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ( $I_E = 0$ )	BDX34	$V_{CBO}$	-45	V
	BDX34A		-60	
	BDX34B		-80	
	BDX34C		-100	
	BDX34D		-120	
Collector-emitter voltage ( $I_B = 0$ )	BDX34	$V_{CEO}$	-45	V
	BDX34A		-60	
	BDX34B		-80	
	BDX34C		-100	
	BDX34D		-120	
Emitter-base voltage		$V_{EBO}$	-5	V
Continuous collector current		$I_C$	-10	A
Continuous base current		$I_B$	-0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		$P_{tot}$	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		$P_{tot}$	2	W
Operating free air temperature range		$T_J$	-65 to +150	°C
Storage temperature range		$T_{stg}$	-65 to +150	°C
Operating free-air temperature range		$T_A$	-65 to +150	°C

NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.  
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

**PRODUCT INFORMATION**

**electrical characteristics at 25°C case temperature (unless otherwise noted)**

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -100 \text{ mA}$	$I_B = 0$	(see Note 3)	BDX34	-45		V
				BDX34A	-60		
				BDX34B	-80		
				BDX34C	-100		
				BDX34D	-120		
$I_{CEO}$ Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$	$I_B = 0$	$T_C = 100^\circ\text{C}$	BDX34		-0.5	mA
				BDX34A		-0.5	
				BDX34B		-0.5	
				BDX34C		-0.5	
				BDX34D		-0.5	
				BDX34		-10	
				BDX34A		-10	
				BDX34B		-10	
				BDX34C		-10	
				BDX34D		-10	
$I_{CBO}$ Collector cut-off current	$V_{CB} = -45 \text{ V}$	$I_E = 0$	$T_C = 100^\circ\text{C}$	BDX34		-1	mA
				BDX34A		-1	
				BDX34B		-1	
				BDX34C		-1	
				BDX34D		-1	
				BDX34		-5	
				BDX34A		-5	
				BDX34B		-5	
				BDX34C		-5	
				BDX34D		-5	
$I_{EBO}$ Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-10	mA
$h_{FE}$ Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -4 \text{ A}$	(see Notes 3 and 4)	BDX34	750		
				BDX34A	750		
				BDX34B	750		
				BDX34C	750		
				BDX34D	750		
$V_{BE(on)}$ Base-emitter voltage	$V_{CE} = -3 \text{ V}$	$I_C = -4 \text{ A}$	(see Notes 3 and 4)	BDX34		-2.5	V
				BDX34A		-2.5	
				BDX34B		-2.5	
				BDX34C		-2.5	
				BDX34D		-2.5	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -8 \text{ mA}$	$I_C = -4 \text{ A}$	(see Notes 3 and 4)	BDX34		-2.5	V
				BDX34A		-2.5	
				BDX34B		-2.5	
				BDX34C		-2.5	
				BDX34D		-2.5	
$V_{EC}$ Parallel diode forward voltage	$I_E = -8 \text{ A}$	$I_B = 0$				-4	V

NOTES: 3. These parameters must be measured using pulse techniques,  $t_p = 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

**PRODUCT INFORMATION**



**thermal characteristics**

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.78	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

**resistive-load-switching characteristics at 25°C case temperature**

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
$t_{on}$ Turn-on time	$I_C = -3$ A	$I_{B(on)} = -12$ mA	$I_{B(off)} = 12$ mA		1		μs
$t_{off}$ Turn-off time	$V_{BE(off)} = 3.5$ V	$R_L = 10$ Ω	$t_p = 20$ μs, dc ≤ 2%		5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

**PRODUCT INFORMATION**

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN  
VS  
COLLECTOR CURRENT

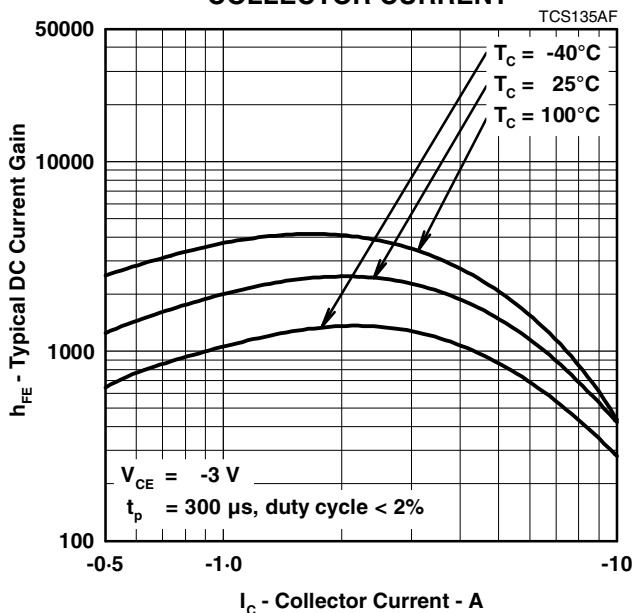


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE  
VS  
COLLECTOR CURRENT

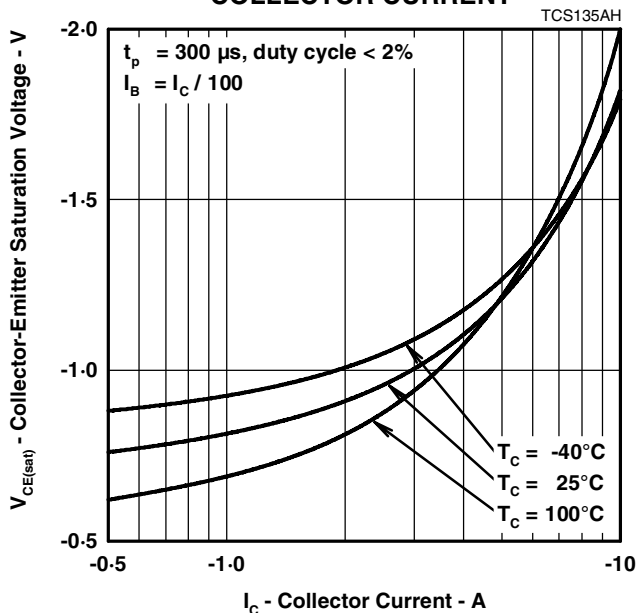


Figure 2.

BASE-EMITTER SATURATION VOLTAGE  
VS  
COLLECTOR CURRENT

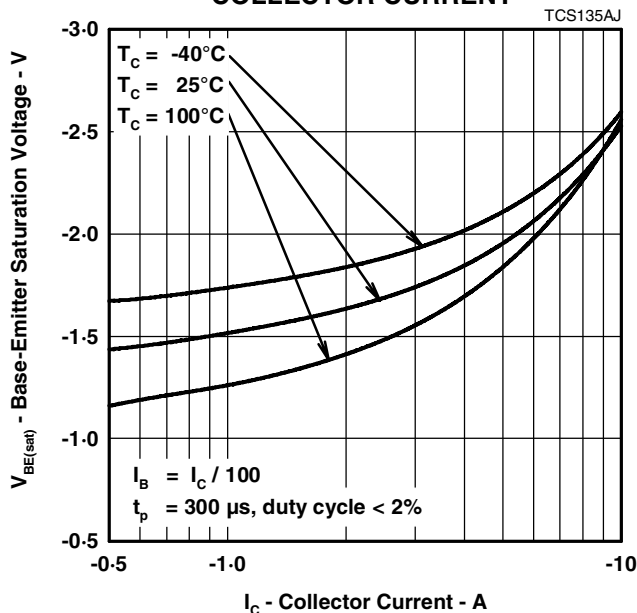
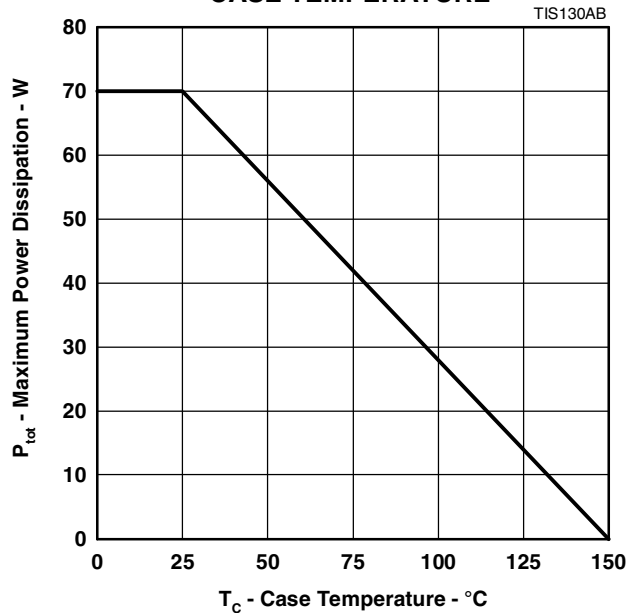


Figure 3.

**PRODUCT INFORMATION**

**THERMAL INFORMATION**

**MAXIMUM POWER DISSIPATION  
vs  
CASE TEMPERATURE**



**Figure 4.**

**PRODUCT INFORMATION**

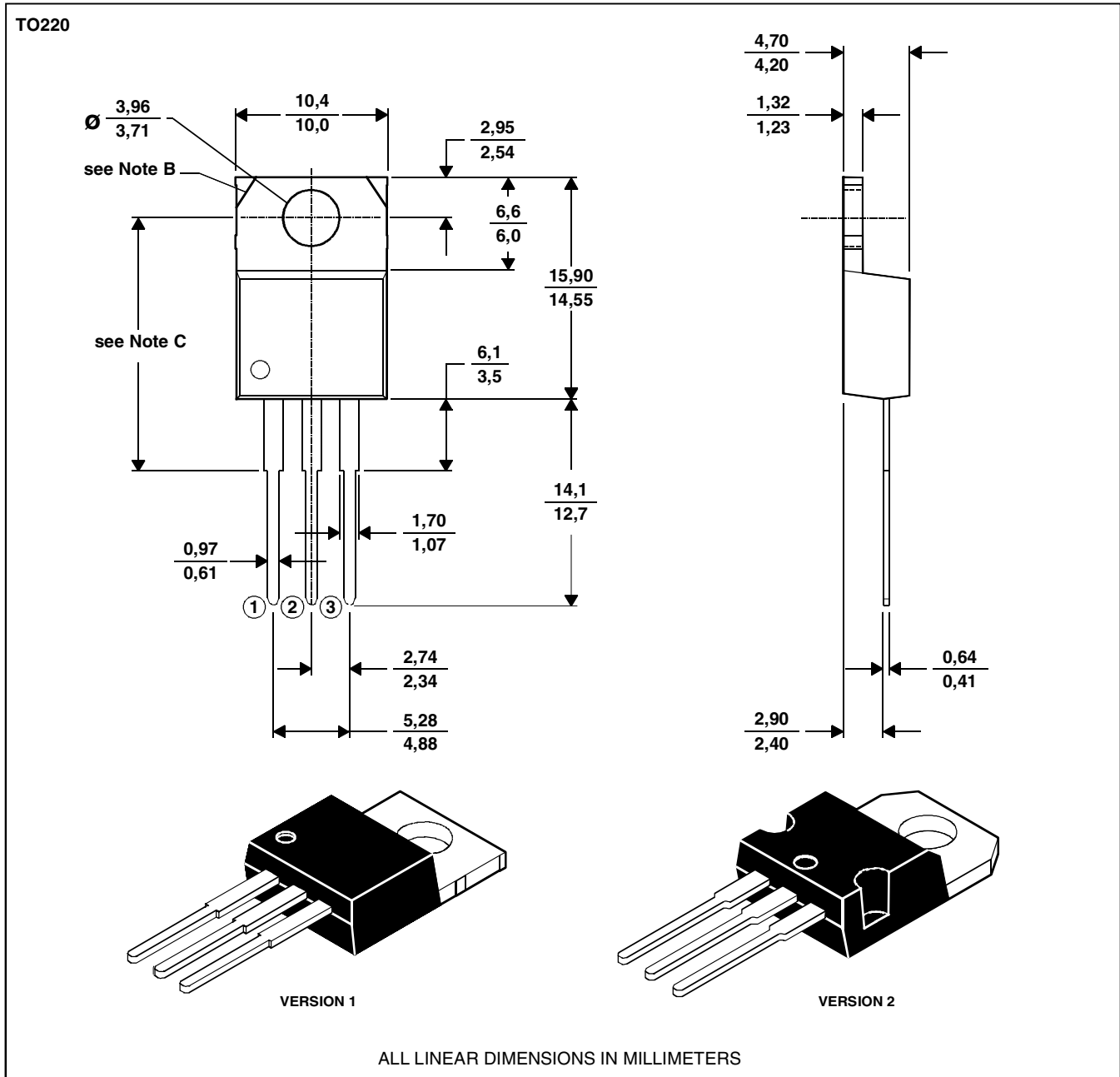
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Specifications are subject to change without notice.

**MECHANICAL DATA**

**TO-220**

**3-pin plastic flange-mount package**

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.  
 B. Mounting tab corner profile according to package version.  
 C. Typical fixing hole centre stand off height according to package version.  
 Version 1, 18.0 mm. Version 2, 17.6 mm.

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**PRODUCT INFORMATION**

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